

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Signey et al.

Serial No: TBD

Filed: 10/11/01

For: METHOD AND SYSTEM FOR CUTTING INTEGRATED CIRCUIT
PACKAGES

L. Nelson
#2/IDS
1-8-02
Docket No.: TI-27954

Examiner: TBD

Art Unit: TBD



INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner for Patents

Washington, DC 20231

Dear Sir:

Please make the references listed on the enclosed PTO-1449 of record under 37 C.F.R. 1.56, 1.97, and 1.98 in the patent application identified above. Copies of the listed references are enclosed.

Respectfully submitted,

A handwritten signature in black ink, appearing to read "Jacqueline J. Garner".

Jacqueline J. Garner
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